

Taiwan Semiconductor

1A, 400V - 1000V Glass Passivated Bridge Rectifier

FEATURES

- Glass passivated junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

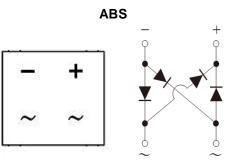
MECHANICAL DATA

- Case: ABS
- Molding compound :meets UL 94V-0 flammability rating
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.12 g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _{F(AV)}	1	А		
V _{RRM}	400 - 1000	V		
I _{FSM}	30	А		
T _{J MAX}	150	°C		
Package	ABS			
Configuration	Quad			







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	ABS4-K	ABS6-K	ABS8-K	ABS10-K	UNIT
Marking code on the device		ABS4	ABS6	ABS8	ABS10	
Repetitive peak reverse voltage	V _{RRM}	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	400	600	800	1000	V
Forward current On glass-epoxy	1	0.8			A	
Forward current On aluminum substrate	I _{F(AV)}	1.0				
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А		
I ² t value (of a surge on-state current)	l ² t	3.74		A ² s		
Junction temperature	TJ	-55 to +150		°C		
Storage temperature	T _{STG}	-55 to +150		°C		



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-lead thermal resistance	R _{θJL}	25	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	80	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage ⁽¹⁾	$I_F = 0.4A, T_J = 25^{\circ}C$	V _F	-	0.95	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$	I _R	-	10	μA
	T _J = 125°C		-	150	μA

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms.

ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
ABSxx-K	RE	G	ABS	1,000 / 7" Plastic reel
(Note 1, 2)	RG		ABS	5,000 / 13" Paper reel

Notes:

1. "xx" defines voltage from 400V (ABS4-K) to 1000V (ABS10-K)

2. Whole series with green compound (halogen-free)

EXAMPLE P/N				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ABS8-K REG	ABS8-K	RE	G	Green compound



Fig.4 Typical Forward Characteristics

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

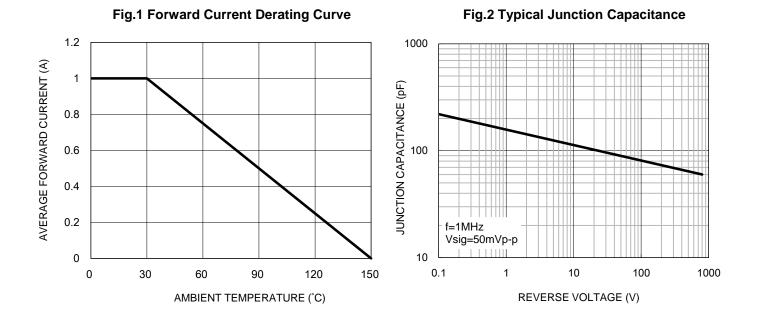
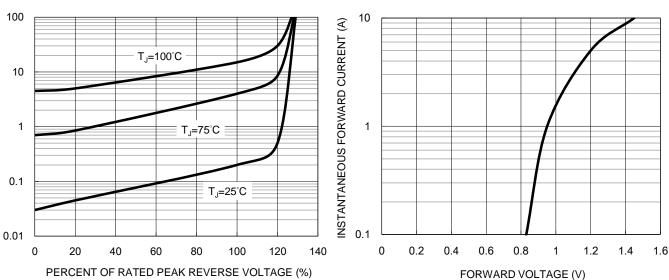


Fig.3 Typical Reverse Characteristics

INSTANTANEOUS REVERSE CURRENT (µA)

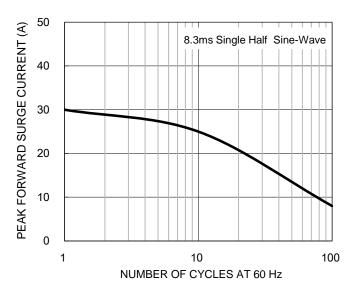




CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

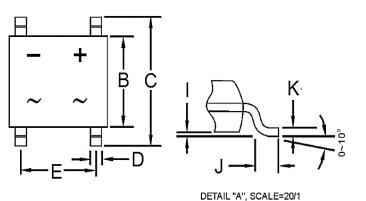
Fig.5 Maximum Non-repetitive Forward Surge Current



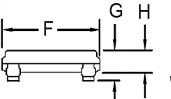


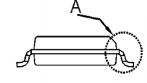
PACKAGE OUTLINE DIMENSIONS

ABS

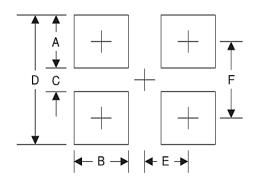


DIM.	Unit (mm)		Unit ((inch)
DIN.	Min.	Max.	Min.	Max.
В	4.30	4.50	0.169	0.177
С	6.25	6.65	0.246	0.262
D	0.60	0.70	0.024	0.028
Е	3.90	4.10	0.154	0.161
F	4.90	5.10	0.193	0.200
G	1.40	1.60	0.055	0.063
Н	1.35	1.45	0.053	0.057
I	0.05	0.15	0.002	0.006
J	0.30	0.70	0.012	0.028
К	0.15	0.25	0.006	0.010





SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.5	0.059
В	0.9	0.035
С	4.22	0.166
D	7.22	0.284
E	2.05	0.081
F	5.72	0.225

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code

F = Factory Code



Taiwan Semiconductor

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